

SSC8L42PN6

N-Channel Enhanced MOSFET

> Features

| VDS | VGS | RDSON Typ. | ID |
|------|-------|------------|------|
| 40)/ | 1201/ | 1.0mR@10V | 1504 |
| 40V | ±20V | 1.5mR@4V5 | 150A |

> Description

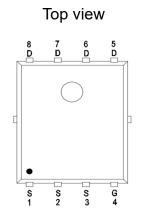
This device is N-Channel enhancement MOSFET. Uses SGT technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit.

- > Applications
- DC/DC converters
- Power supplies
- Motor Drive Control
- Synchronous rectification

> Ordering Information

| Device | Package | Shipping |
|------------|---------|-----------|
| SSC8L42PN6 | PDFN5X6 | 5000/Reel |

Pin configuration





PDFN5X6



Marking

(XX: product year / YY: product week)

> Absolute Maximum Ratings(T_A=25°C unless otherwise noted)

| Symbol | Parameter | | Ratings | Unit |
|------------------|--|----------------------|---------|------|
| V _{DSS} | Drain-to-Source Vol | tage | 40 | V |
| V _{GSS} | Gate-to-Source Volt | tage | ±20 | V |
| | Continuous Drain Current ^d | Tc=25℃ | 150 | |
| lo | | Tc=100°C | 95 | A |
| | Continuous Drain Current ^a | T _A =25℃ | 46 | |
| IDSM | | T _A =70°C | 34 | A |
| I _{DM} | Pulsed Drain Curre | 500 | А | |
| _ | Power Dissipation ^c | Tc=25℃ | 78 | 14/ |
| PD | | Tc=100℃ | 32 | W |
| P | Power Dissipation ^a | T _A =25℃ | 7.0 | 14/ |
| Pdsm | | T _A =70℃ | 4.5 | W |
| las | Avalanche Current ^b L=0.5ml | 42 | А | |
| Eas | Avalanche Energy ^b L=0.5m | H Single Pulse | 441 | mJ |
| TJ | Operation junction temperature | | -55~150 | °C |
| Tstg | Storage temperature | -55~150 | °C | |

> Thermal Resistance Ratings($T_A=25^{\circ}$ unless otherwise noted)

| Symbol | Parameter | Ratings | Unit |
|------------------|---|---------|-------|
| R _{θJA} | Junction-to-Ambient Thermal Resistance ^a | 17 | °C/W |
| R _{θJC} | Junction-to-Case Thermal Resistance | 1.5 | C/ VV |

Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A=25°C.The value in any given application depends on the user is specific board design. The power dissipation is based on the t ≤ 10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

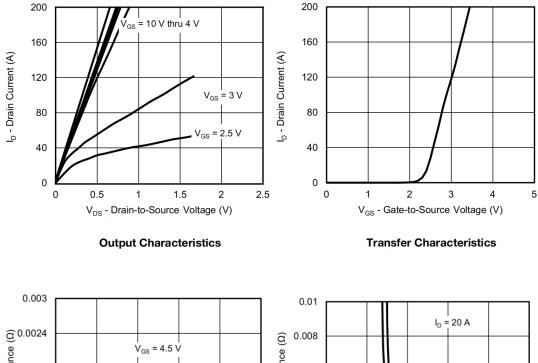


Electronics Characteristics(T_A=25°C unless otherwise noted)

| Symbol | Parameter | Test Conditions | Min | Тур. | Max | Unit |
|----------------------|------------------------------------|------------------------|-----|------|------|------|
| V _{(BR)DSS} | Drain-Source Breakdown Voltage | VGS=0V, ID=250uA | 40 | | | V |
| $V_{GS \ (th)}$ | Gate Threshold Voltage | VDS=VGS, ID=250uA | 1.4 | 1.9 | 2.4 | V |
| D | Drain-Source On- | VGS=10V , ID=50A | | 1.0 | 1.24 | D |
| $R_{DS(on)}$ | Resistance | VGS=4.5V , ID=50A | | 1.5 | 2.1 | mR |
| I _{DSS} | Zero Gate Voltage Drain Current | VDS=40V, VGS=0V | | | 1.0 | uA |
| I _{GSS} | Gate-Source leak current | VGS=±20V, VDS=0V | | | ±100 | nA |
| G _{FS} | Transconductance | VDS=5V, ID=20A | | 110 | | S |
| V _{SD} | Forward Voltage | VGS=0V, IS=20A | | | 1.3 | V |
| Rg | Gate Resistance | VDS=0V, f=1MHz | | 2.3 | | R |
| Ciss | Input Capacitance | | | 5900 | | |
| Coss | Output Capacitance | VDS=20V, VGS=0V, | | 2100 | | pF |
| Crss | Reverse Capacitance | f=1MHz | | 112 | | |
| T _{D(ON)} | Turn-on delay time | | | 23 | | |
| Tr | Rise time | VGS=10V, RL=0.4R | | 64 | | |
| Td(off) | Turn-off delay time | VDS=20V , RG=4.7R | | 88 | | ns |
| Tf | Fall time | | | 30 | | |
| QG | Total Gate Charge | | | 86 | | |
| Q _{GS} | Gate Source Charge | VGS=10V, VDS=20V | | 27 | | nC |
| Q _{GD} | Gate Drain Charge | ID=50A | | 9 | | |
| Trr | Diode Recovery Time | IF=37A , di/dt=100A/us | | 65 | | ns |
| Qrr | Diode Recovery Charge | IF=37A , di/dt=100A/us | | 72 | | nC |



> Typical Characteristics(T_A=25°C unless otherwise noted)



0.006

0.004

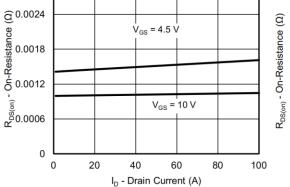
0.002

0

0

 $T_J = 25 °C$

2



On-Resistance vs. Drain Current



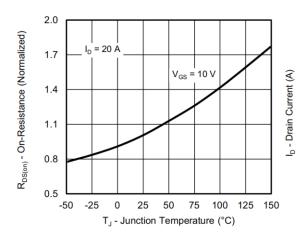
6

4

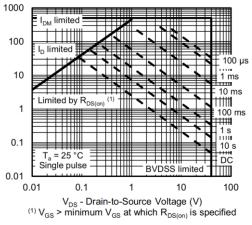
T_J = 125 °C

8

10



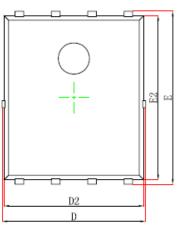
On-Resistance vs. Junction Temperature



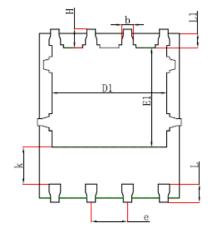




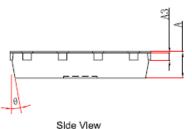
Package Information







<u>Bottom Vlew</u> [背视图]



<u>Slde Vlew</u> [側视图]

| Symbol | Dimensions | In Millimeters | Dimension | is In Inches |
|--------|------------|----------------|-----------|--------------|
| | Min. | Max. | Min. | Max. |
| А | 0.900 | 1.000 | 0.035 | 0.039 |
| A3 | 0.254 | 4REF | 0.01 | OREF |
| D | 4.944 | 5.096 | 0.195 | 0.201 |
| E | 5.974 | 6.126 | 0.235 | 0.241 |
| D1 | 3.910 | 4.110 | 0.154 | 0.162 |
| E1 | 3.375 | 3.575 | 0.133 | 0.141 |
| D2 | 4.824 | 4.976 | 0.190 | 0.196 |
| E2 | 5.674 | 5.826 | 0.223 | 0.229 |
| k | 1.190 | 1.390 | 0.047 | 0.055 |
| b | 0.350 | 0.450 | 0.014 | 0.018 |
| е | 1.27 | 1.270TYP | | OTYP |
| L | 0.559 | 0.711 | 0.022 | 0.028 |
| L1 | 0.424 | 0.576 | 0.017 | 0.023 |
| Н | 0.574 | 0.726 | 0.023 | 0.029 |
| θ | 10° | 12° | 10° | 12° |



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